

## *Microsemi*,

### ULTRAFAST SOFT RECOVERY RECTIFIER DIODE

### **PRODUCT APPLICATIONS**

- Anti-Parallel Diode -Switchmode Power Supply -Inverters
- Free Wheeling Diode -Motor Controllers -Converters -Inverters
- Snubber Diode
- PFC

### PRODUCT FEATURES

- Ultrafast Recovery Times
- Soft Recovery Characteristics
- · Popular TO-220 Package
- · Low Forward Voltage
- · Low Leakage Current
- Avalanche Energy Rated

### PRODUCT BENEFITS

- Low Losses
- · Low Noise Switching
- Cooler Operation
- · Higher Reliability Systems
- Increased System Power Density



1 - Cathode 2 - Anode

Back of Case - Cathode

### **MAXIMUM RATINGS**

-			
Symbol	Characteristic / Test Conditions	APT30DQ120K(G)	UNIT
V <sub>R</sub>	Maximum D.C. Reverse Voltage		
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage	1200	Volts
$V_{RWM}$	Maximum Working Peak Reverse Voltage		
I <sub>F(AV)</sub>	Maximum Average Forward Current (T <sub>C</sub> = 103°C, Duty Cycle = 0.5)	30	
I <sub>F(RMS)</sub>	RMS Forward Current (Square wave, 50% duty)	43	Amps
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current ( $T_J = 45^{\circ}C$ , 8.3ms)	210	
E <sub>AVL</sub>	Avalanche Energy (1A, 40mH)	20	mJ
T_,T <sub>STG</sub>	Operating and StorageTemperature Range	-55 to 175	
Τ <sub>L</sub>	Lead Temperature for 10 Sec.	300	- °C

### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		MIN	ТҮР	MAX	UNIT
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 30A		2.8	3.3	
		I <sub>F</sub> = 60A		3.4		Volts
		I <sub>F</sub> = 30A, T <sub>J</sub> = 125°C		2.1		
I <sub>RM</sub>	Maximum Reverse Leakage Current	V <sub>R</sub> = 1200V			100	μA
		V <sub>R</sub> = 1200V, T <sub>J</sub> = 125°C			500	
C <sub>T</sub>	Junction Capacitance, V <sub>R</sub> = 200V			36		pF

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### 1200V 30A APT30DQ120K APT30DQ120KG\* \*G Denotes RoHS Compliant, Pb Free Terminal Finish.

All Ratings:  $T_c = 25^{\circ}C$  unless otherwise specified.

### **DYNAMIC CHARACTERISTICS**

### APT30DQ120K(G)

Symbol	Characteristic	Test Conditions	MIN	ТҮР	MAX	UNIT
t <sub>rr</sub>	Reverse Recovery Time I <sub>F</sub> = 1A, di <sub>F</sub> /dt =	-100A/μs, V <sub>R</sub> = 30V, T <sub>J</sub> = 25°C	-	26		nc
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 30A, di <sub>F</sub> /dt = -200A/μs V <sub>R</sub> = 667V, T <sub>C</sub> = 25°C	-	320		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	545		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	4	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 30A, di <sub>F</sub> /dt = -200A/μs V <sub>R</sub> = 667V, T <sub>C</sub> = 125°C	-	435		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	2100		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	9	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 30A, di <sub>F</sub> /dt = -1000A/µs V <sub>R</sub> = 667V, T <sub>C</sub> = 125°C	-	180		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	2975		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	28		Amps

### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	ТҮР	MAX	UNIT
R <sub>ØJC</sub>	Junction-to-Case Thermal Resistance			.80	°C/W
W <sub>T</sub>	Package Weight		0.07		οz
			1.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

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Figure 7. Maximum Average Forward Current vs. CaseTemperature











TO-220 (K) Package Outline e3 100% Sn

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